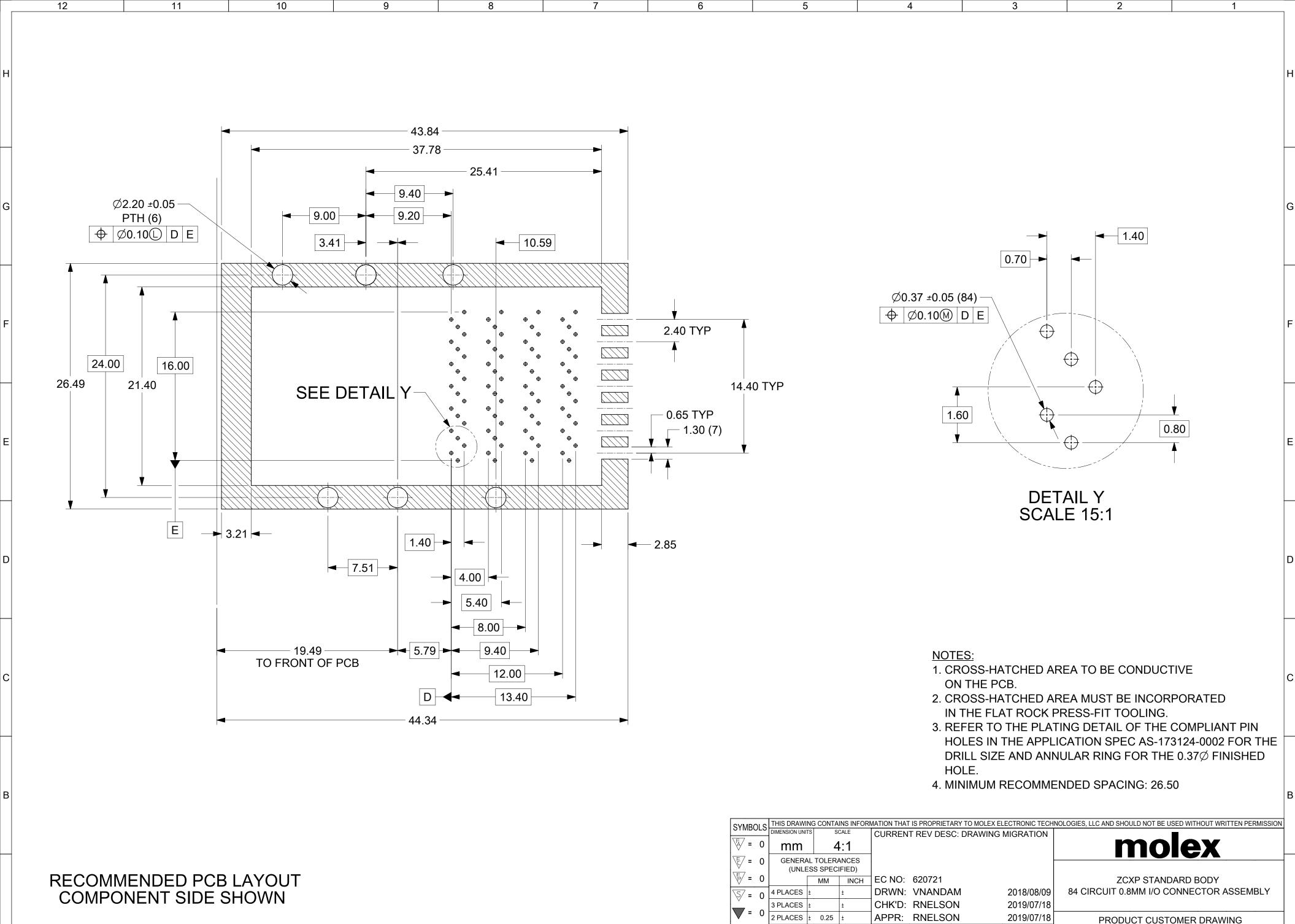
12 11	10 9 8	7 6	5 4	3 2 1
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E GROUND				E
SIGNAL	SEE DETAIL 2 18.20 AT BASE OF CARD SLOT			173161-0003
	Z	7.00		DATE CODE
			3.41 →   -   -   -   -   -   -   -   -   -	1.11
c DETAIL 2	◄─── 24.00 ──►	FROM DIECAST TOP	5.06 9.20 +0.15	
SCALE 6:1 <u>NOTES:</u> 1. MATERIALS: CONNECTOR HOUSING: HIGH TEMPE GLASS-FILLED, UL 94V-O EMI HOUSING: NICKEL PLATED DIE CA		TO BOTTOM SURFACE	→ 9.20 ±0.15	
COVER: STAINLESS STEEL ALLOY B EMI GASKET: CONDUCTIVE FABRIC C	OVER FOAM UL 94 V-0			MATERIAL # DESCRIPTION 1731610003 NO COVER B
TERMINALS: COPPER ALLOY 2. PLATING:			SYMBOLS         THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO IDIMENSION UNITS         SCALE         CURRENT REV DESC: DRAMING	1731610004 WITH COVER MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
CONTACT AREA: 0.76µm MIN. GOLD C TIN TAIL AREA: 0.76µm - 1.52µm TIN O			$\overrightarrow{V} = 0 \qquad \text{mm} \qquad 2:1$ $\overrightarrow{V} = 0 \qquad \text{general tolerances}$	molex
3. THIS CONNECTOR IS DESIGNED TO MA SERIES INDICATED IN THE MOLEX PRO			$\frac{1}{100} = 0 \qquad (UNLESS SPECIFIED) \\ \hline MM INCH EC NO: 620721$	ZCXP STANDARD BODY 2018/08/09 84 CIRCUIT 0.8MM I/O CONNECTOR ASSEMBLY
4. REFER TO ROUTING GUIDE AS-173124- 5. PACKAGING SPECIFICATION: TRAY PAG			$\checkmark$ = 04 PLACES ±±DRWN: VNANDAM $\checkmark$ 3 PLACES ±±CHK'D: RNELSON $\checkmark$ 2 PLACES ±0.25 ±APPR: RNELSON	2019/07/18
A 6. REFER TO AS-170465-0001 FOR THE AF 7. MOUNTING HARDWARE REQUIRED: M2	PPLICATION SPECIFICATION.		$\nabla = 0$ 1 PLACE ± ± INITIAL REVISION:	DOCUMENT NUMBER DOC TYPE DOC PART REVISION A
MOUNTING SCREW LENGTH: BOARD T			ANGULAR TOL ± 0.5° APPR: SVANG01 = 0 DRAFT WHERE APPLICABLE THIRD ANGLE PROJECTION DRA	2010/04/07         SD-173161-0003         PSD         001         A           2016/04/08         MATERIAL NUMBER         CUSTOMER         SHEET NUMBER
DOCUMENT STATUS         P1         RELEASE DATE         20           FORMAT: Englange masked-to-prod/C REVISION: D DATE: 2016/01/19         12         11	019/07/18 15:33:06 10 9 8	7 6	Image: Second system     MUST REMAIN WITHIN DIMENSIONS     Image: Second system     Image: C-Second system       5     4	SIZE         173161         SEE CHART         GENERAL MARKET         1 OF 4           3         2         1



PCB THICKNESS: 1.57mm MIN.

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1 PLACE

0 PLACES

= 0

ANGULAR TOL ± 0.5 °

DRAFT WHERE APPLICABLE

MUST REMAIN

WITHIN DIMENSIONS

APPR:	RNELSC	N
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SD-173161-0003

CUSTOMER

**GENERAL MARKET** 

2016/04/07

2016/04/08

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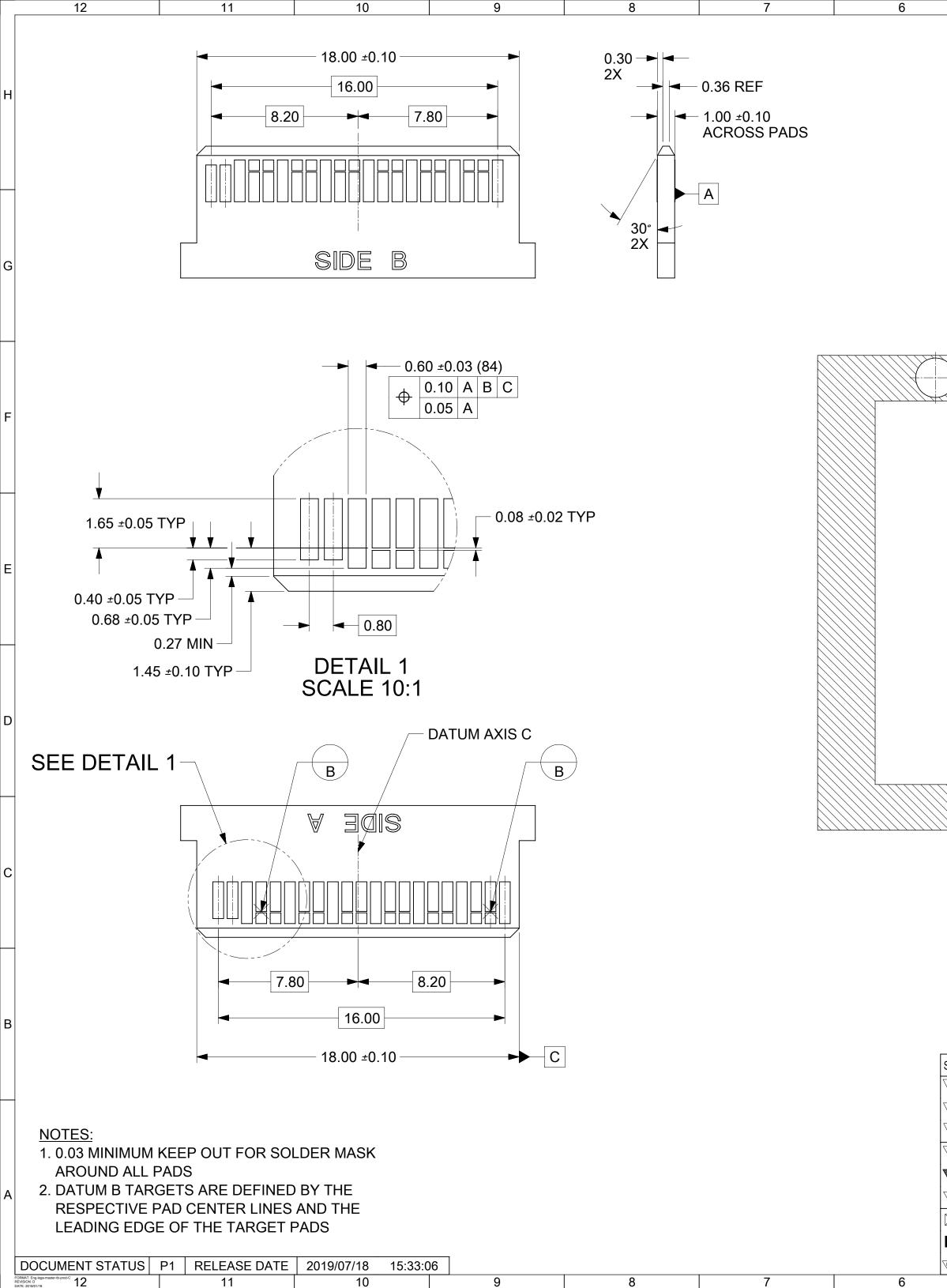
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2 OF 4

PSD 001



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SYMB	า เร	THIS DRAWIN	NG CONTA	INS INF	ORMATION THAT	IS PROPRIET	ARY TO MOLEX E	LECTRONIC TECH	NOLOGIES, LLC AN	ID SHO	JLD NOT BE US	SED WITH	HOUT WRI	TTEN PER	MISSION	1
		DIMENSION UNIT	's s	CALE	CURREN	T REV DES	C: DRAWING	MIGRATION								
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F =	0		MM	INC	H EC NO:	620721				ZC	KP STAND	ARD E	BODY			
<u></u> =	0	4 PLACES	±	±	DRWN:	VNANDA	M	2018/08/09	84 CIRCU	IT 0.8	MM I/O CO	ONNE	CTOR A	SSEM	3LY	
v	0	3 PLACES	±	±	CHK'D:	RNELSC	N	2019/07/18								
=	0	2 PLACES	± 0.25	±	APPR:	RNELSC	N	2019/07/18	PF	RODU	CT CUSTO	OMER	DRAW	ING		
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		5				4		3		2				1		-

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173161-0004	173161-0003
BRACKET 19.66 CONNECTOR ASSEMBLY C EMI GASKET ALIGNMENT PEG ASSEMBLED VIEW	RECOMMENDED I/O BRACKET CUT-OUT (NOT SUPPLIED)
	SYMBOLSIHIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION $\overrightarrow{W} = 0$ mm2:1CURRENT REV DESC: DRAWING MIGRATION $\overrightarrow{W} = 0$ GENERAL TOLERANCES (UNLESS SPECIFIED)EC NO: 620721ZCXP STANDARD BODY $\overrightarrow{V} = 0$ 4 PLACES $\pm$ ±DRWN: VNANDAM2018/08/09 $\overrightarrow{V} = 0$ 4 PLACES $\pm$ ±CHK'D: RNELSON2019/07/18 $\overrightarrow{V} = 0$ 4 PLACES $\pm$ ±APPR: RNELSON2019/07/18PRODUCT CUSTOMER DRAWING
DOCUMENT STATUS         P1         RELEASE DATE         2019/07/18         15:33:06           VIDUAL Exploration of Data Status         10         9         8         7	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $